

深圳市索瑞达电子有限公司

承 认 书 SPECIFICATION FOR APPROVAL

索瑞达料号: Sorede P/N:	SNH.4020.TYB6R8MT00	
产 品 名 称 : Product Name:	功率电感	
客户料号: Customer P/N:		
Customer Name :		
客户名称:		





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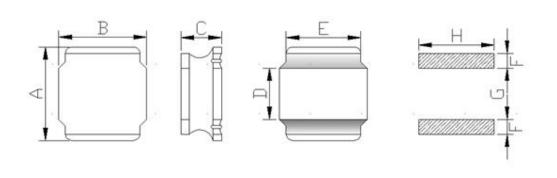
修改履历表

Modify Resume

修改日期			修改明细	修改后版本号
Date modified			Modify Details	Version No.
2020-09-21	文件新制订	File formulation		A

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1、外形尺寸 Dimension:



单位Unit: mm

4.00±0.2
4.00±0.2
2.0 Max
1.7±0.3
3.2 Ref
1.3 Ref
1.6 Ref
3.7 Ref

2、产品品名构成 Product Spec. Model

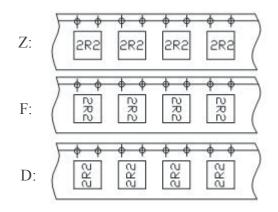
<u>SNH 4020T Y B - 6R8 M</u> a b c d e f

- a: 系列名称Series name
- b: 产品尺寸Product dimensions (AxBxC)
- c: 密封方式Sealing way (L: 冷封Cold seal Y: 热封Heat seal)
- d: 印字方向 Lettering direction ▶
- e: 电感值Inductance Value

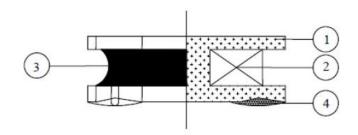
(1R0:1.0uH; 100: 10uH; 101:100uH)

f: 电感公差Inductance Tolerance (K:10%; M:20%; N:30%)

► Lettering direction



3、结构Structure



4、材料清单MATERIAL LIST

NO.	PARTS	MATERIAL SPECIFICATIONS	UL FILE NO.	TEMP. CLASS
1	CORE	ALLOY CORE OR EQUIVALENT	NA	NA
2	WIRE	POLYURETHANE ENAMELLED COPPER WIRE OR EQUIVALENT	E258243	180℃
3	ADHESIVE	EPOXY RESIN OR EQUIVALENT	NA	NA
4	SOLDER	Sn99.3-Cu0.7 OR EQUIVALENT	NA	NA

*NA.NOT APPLICABLE.

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5、电性能参数表 Electrical Characteristics List

规格型号 Part NO.	电感量 Tolerance(µH)	测试频率 Test Freq. (kHz/v)	直流电阻 DC Max (Ω)	饱和电流 Isat (A)	温升电流 Irms (A)
SNH.4020.TYB6R8MT00	6.8	100/0.25	0.160	3.00	2.40

[※]公差Tolerance: N:±30%、M:±20%、K:±10%.

额定电流:指使电感量比初始值下降30%或电感器表面温度上升 40℃的电流值(参考周围环境温度 25℃)。 The rated DC current is that which cause at 30% inductance reduction from the initial value or inductor surface temperature to rise by 40℃, whichever is smaller (Reference ambient temperature 25℃)。

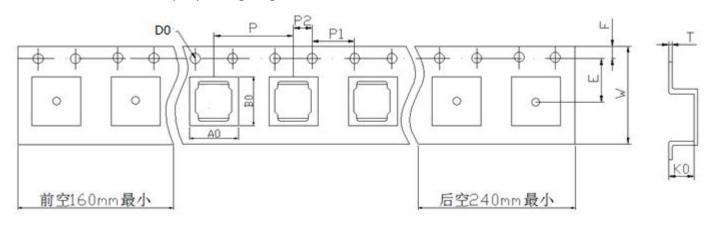
[※]工作温度Operating temperature rang: -40 $^{\circ}$ to +125 $^{\circ}$ (Including Self-heating)

[※]储存温度Storage termperature rang: -40 $^{\circ}$ to +125 $^{\circ}$

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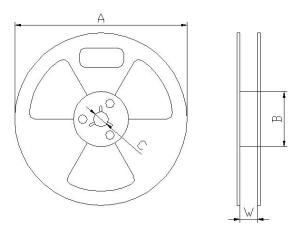
6、产品包装 Packaging

1) 载带包装示意图 Tape packing diagram



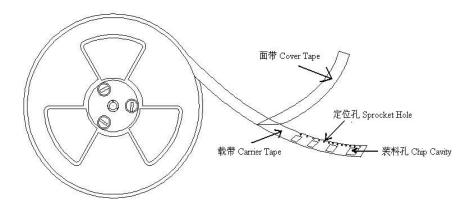
ITEM	W	A0	В0	K0	P	Е	F	D0	Р0	P2	Т
DIM	12.00	4.30	4.30	2.20	8.00	5.50	1.75	1.50	4.00	2.00	0.30
TOLE	±0.3	±0.1	±0.1	±0.1	±0.1	±0.1	±0.1	+0.1	±0.1	±0.1	±0.05

2)卷盘包装示意图 Tape packing diagram



А	330±0.5
В	100±0.5
С	13.5±0.5
W	12.5±0.5

3) 卷盘包装示意图 Tape packing diagram

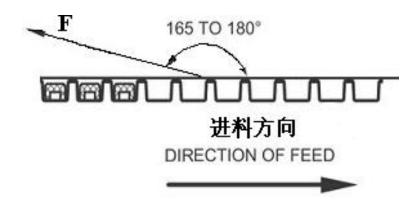


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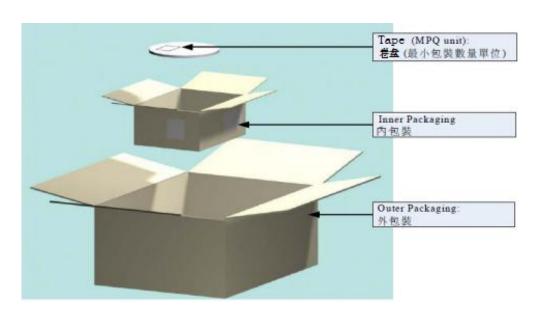
4) 剥离强度要求Peeling required

①F 力大小: 20~100g;

②面带剥离角度: 165°~180°。



5) 包装数量 Packing quantity



项目 (Project)	数量 (PCS)	尺寸规格(Size:mm)
盘(Reel)	3000	13"
内盒 (Inner box)	12000	340mm*340mm*65mm
外箱 (Out box)	24000	360mm*360mm*160mm

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7. RELIABILITY TEST METHOD

TESTITEM	SPECIFICATION	TEST DETAILS					
Substrate bendi	∠L/Lo≦±5%	The sample shall be soldered onto the printed circuit board					
		in figure 1 and a load applied unitil the figure in the arrow					
	There shall be	rection is made approximately 3mm.(keep time 30 seconds)					
	no mechanical	PCB dimension shall the page 7/9					
	damage or elec-	F(Pressurization)					
	trical damege.						
		\frac{1}{2}					
		R5 45±2 45±2					
		PRESSURE ROD figure-1					
Vibration	<u></u>	The sample shall be soldered onto the printed circuit board					
		and when a vibration having an amplitude of 1.52mm					
	There shall be	and a frequency of from 10 to 55Hz/1 minute repeated should					
	no mechanical	be applied to the 3 directions (X,Y,Z) for 2 hours each.					
	damage.	(A total of 6 hours)					
Solderability	New solder	Flux (rosin, isopropyl alcohol{JIS-K-1522}) shall be coated					
	More than 90%	over the whole of the sample before hard, the sample shall					
		then be preheated for about 2 minutes in a temperature of					
		$130{\sim}150^\circ\!\mathrm{C}$ and after it has been immersed to a depth 0.5mm					
		below for 3±0.2 seconds fully in molten solder M705 with					
		a temperature of 245±2℃.					
		More than 90% of the electrode sections shall be couered					
		with new solder smoothly when the sample is taken out of					
		the solder bath.					

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MECHANICAL				1 0						
TESTITEM	SPECIFICATION									
Resistance to	There shall be	Tempe	erature profile of r	eflow soldering						
Soldering heat	no damage or									
(reflow soldering)	problems.	The specimen shall be production shown in the attraction and the specimen shall be stored to the specimen shall be	Pre-heating 2 min passed through the above profile for 1 stored at standar	time. (Stor tempe) 2 min. c he reflow oven with time.	the					
ELECTRICAL										
TESTITEM	SPECIFICATION		TEST DETA	ILS						
Insulation resistance	There shall be no other damage or problems.	DC 100V voltage shall be surface and the termina The insulation resistance	l.							
Dielectric	There shall be	AC 100V voltage shall b	e applied for 1 m	inute acrosset the	top					
withstand	no other	surface and the termina	l of this sample							
voltage	damage or problems.									
Temperature	△L/L20°C ≦±10%	The test shall be perforn	ned after the san	nple has stabilized	in					
characteristics	0~2000 ppm/°C	an ambient temperature of - 40 to + 125 $^\circ$ C ,and the value								
		calculated based on the	value applicable	in a normal						
		temperature and narmal	humidity shall b	e	0%.					

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TEST ITEM	SPECIFICATION								
High temperature	△L/Lo≦±5%	The sam	The sample shall be left for 500hours in an atmospere with						
storage		a tempei	a temperature of 125±2°C and a normal humidity.						
	There shall be	Upon co	Jpon completion of the measurement shall be made after the						
	no mechanical	sample h	sample has been left in a normal temperature and normal						
	damage.	humidity	numidity for 1 hour.						
Low temperature	∆L/Lo≦±5%	The sam	ple sh	all be left for 500 hours in	an atmosphere with				
storage		a temper	rature o	of -40±3℃.					
	There shall be	Upon co	mpletio	on of the test, the measure	ement shall be made				
	no mechanical	after the	sampl	e has been left in a norma	al temperature and				
	damage.	normal h	umidit	y for 1 hour.					
Change of	△L/Lo≦±5%	The sam	ple sh	all be subject to 5 continu	os cycles, such as shown				
temperature		in the tal	ole 2 b	elow and then it shall be s	subjected to standard				
	There shall be	stmosph	eric co	onditions for 1 hour, after v	vhich measurement				
	no other dama-	shall be	shall be made.						
	ge of problems								
			table 2						
				Temperature	Duration				
			1	-40 ± 3℃	10 min.				
				(Themostat No.1)					
			2	Standard	5 sec. or less				
				atmospheric	No.1→No.2				
			3	125±2℃	30 min.				
				(Themostat No.2)					
			4	Standard	5 sec. or less				
				atmospheric	No.2→No.1				
Moisuture storage	△L/Lo≦±5%	The sam	ple sh	all be left for 500 hours in	a temperature of				
		40±2°C a	and a h	numidity(RH) of 90 \sim 95%.					
	There shall be	Upon co	mpletio	on of the test, the measure	ement shall be made				
		after the sample has been left in a normal temperature and							
	no mechanical	after the	Sampi	e nas been leit in a norma	ir temperature and				

The sample shall be reflow soldered onto the printed circuit board in every test.

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8、注意事项 Note

①本承认书保证我司产品作为一个单体时的质量情况。当我司产品被安装到贵司产品上时,请保证 贵司的产品已根据贵司的规范进行了有效评估和确认。

This product specification guarantees the quality of our product as a single unit. Please make sure that your product is evaluated and confirmed against your specifications when our product is mounted to your product.

②如果贵司对我司产品的使用已超过了本承认书所界定的产品功能,那么对于由此引发的失效, 我司将不予保证。

We cannot warrant against failure caused by any use of our product that deviates from the intended use as described in this product specification.

- ③为了保持终端电极的焊接性,并使包装材料保持良好状态,必须控制储存区的温度和湿度。
 To maintain the solderabilty of terminal electrodes and to keep the packing material in good condition, temperature and humidity in the storage area should be controlled.
 - ※建议的条件: -10~+40℃, 30~70%RH。

Recommended conditions: $-10 \sim +40^{\circ}$ C, $30 \sim 70\%$ RH.

※储存超过六个月的,应在实际使用前进行焊接检验。
In case of storage over 6 months, soldrability shall be checked before actual usage.

※即使在理想的储存条件下,产品的可焊性也随着时间的推移而降低。因此,产品应从交货时算起, 建议8个月之内使用完。

Even under ideal storage conditions, the weldability of the product decreases over time. therefore, the product should be From the time of delivery, it is recommended that it be used within 8 months.

④本承认书在客户收到30天之内,必须签章返回,逾期视为默认。

The Specification Approval should be sent back to the supplier with customer's chop on it within 30 days after receiving it, or we will take it as approved by customer's automatically.

⑤如有特殊规格要求,请事前联络我司技术部人员。

In case of special specifications please contact our technical department prior staff.